High Power RSOA 4-Emitter Chip



## Part Number: CHPm-179

High Power 4 Emitters Gain Chip Single-Mode RSOA CW Wavelength at 1550nm

#### Features

- High Output Power
- High Dynamic Range
- High Efficiency
- 4 Emitters Mini Array
- Cost Effective

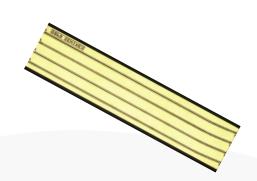
#### Application

- FMCW LiDAR
- Datacom
- Data Centers
- Telecom OTDR
- Telecom Optical Comm



SemiNex delivers the highest available power at infrared wavelengths between 12xx and 19xx nm. When necessary, we will further optimize the design of our InP & GaSb laser chips to meet our customers' specific optical and electrical performance needs. Diodes, bars and packages are tested to meet customer and market performance demands. Typical results and packaging options are shown. Contact SemiNex for additional details or to discuss your specific requirements.

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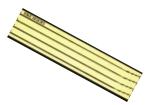


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#### Specification

CHPm-179



Optical	Symbol	Тур.	Units
Center Wavelength	λς	1550	nm
ASE Output Power @1A* per channel	Pout	0.2	Watts
Aperture Width	AW	4	μm
Aperture Height	AH	1	μm
Number of Emitters		4	127µm pitch
3dB Bandwidth	BW	80	nm
Beam Exit Angle	θεχτ	19.5	degree
Polarization Extinction Ratio	PER	18	dB
Fast Axis Div.	Θ⊥	30	deg FWHM
Slow Axis Div.	Θ <sub>II</sub>	20	deg FWHM
Front Facet Reflectivity		<0.1%	
Rear Face Reflectivity		98%	
Waveguide		Curved	
Electrical	Symbol		Units
Operating Current per channel	lop	1	А
Operating Voltage	V <sub>op</sub>	2	V
Mechanical		Range	Units
Chip Width		625	μm
Operating Temp.**		-20 to 75	°C
Storage Temp.		-40 to 85	°C

\*Specified values are rated at a constant heat sink temperature of 20°C. \*\*High temperature operation will reduce performance and MTTF. Unless otherwise indicated all values are nominal.

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## High Power RSOA 4-Emitter Chip



# LASER RIDGE, PLANAR WITH TOP SURFACE

CHIP ATTRIBUTES				
WAVELENGTH	1550nm ±20nm			
APERTURE WIDTH	4µm±1µm			
EMITTER QTY	4			
EMITTER PITCH	127µm±1µm			
THICKNESS	160µm±10µm			
CAVITY LENGTH	2.5mm±10µm			

P-METAL				
MATERIAL	THICKNESS (nm)	TOLERANCE (nm)		
Ti	50	±10		
Pt	125	±25		
Αu	250	±50		

N-METAL				
MATERIAL	THICKNESS (nm)	TOLERANCE (nm)		
Ti	30	±10		
Pt	125	±25		
Au	400	±40		

0.0 P-SIDE FULLY METALIZED SURFACE

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